Product name:	Product code:
Black Hole PCB Metallization System	CMI-NP-1823



Description

Black Hole PCB Metallization System is a compact system using carbon dispersion for hole metallization before copper plating.

Technical specification

Heater	PTFE or titanium, with controller

Standard Accessories

- Anodes
- Racks
- Chemical kit

The Black Hole PCB Metallization System is a compact system using carbon dispersion for hole metallization before copper plating. It is designed for through-hole plating and chemical metallization of double sided and multilayer PCBs in a lab.

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Features

- Corrosion-resistant PP or PVC construction
- Digital temperature and timer controls
- Fume extraction connection
- Complete small-scale hole plating process

Technical Specifications

Process	Carbon, 4 steps
Tanks	4 nos
Capacity	A4 board
Supply	230 V AC, 50 Hz, single phase
Tank material	Polypropylene